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Heat conduction in 2D strongly coupled dusty plasmas

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Abstract

We perform non-equilibrium simulations to study heat conduction in two-dimensional strongly coupled dusty plasmas. Temperature gradients are established by heating one part of the otherwise equilibrium system to a higher temperature. Heat conductivity is measured directly from the stationary temperature profile and heat flux. Particular attention is paid to the influence of damping effect on the heat conduction. It is found that the heat conductivity increases with the decrease of the damping rate, while its magnitude agrees with previous experimental measurement.

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(Some figures in this article are in colour only in the electronic version)

Introduction

Recently, experiments were carried out to study thermal conduction in two-dimensional (2D) strongly coupled dusty plasmas (SCDPs) [1, 2] in both crystalline and solid/liquid mixture states, and a thermal conductivity, which is independent of temperature, was found. Although both these experiments were aimed at studying the heat conduction at an atomic (molecular) level, neither of them showed many details of microscopic processes during the heat transfer. Therefore, we conduct here non-equilibrium simulations by using the Brownian dynamics method [3] to study heat transfer in 2D SCDPs in more detail, serving as a supplement to real experiment.

Numerical simulation

$N = 10\,000$ particles are simulated in a rectangular area with periodical boundary condition in the y direction and confining boundary condition in the x direction. (More details of the simulation and the algorithm may be found in [3].) Particles interact with each other via the pairwise Yukawa potential: $\phi(r) = (Q^2/r) \exp(-r/\lambda_D)$, with Q , r and λ_D being the particle charge, interparticle distance and screening length, respectively. The strong-coupling strength is given by $\Gamma = Q^2/(ak_B T)$, and the screening parameter by $\kappa = a/\lambda_D$, where $a = (\pi n)^{-1/2}$ is the 2D Wigner–Seitz radius with n being the areal number density and $k_B T$ being the

system temperature. In addition, the damping coefficient γ is needed to fully characterize the dynamics of the system. To simplify later discussion, we also introduce here the nominal plasma frequency $\omega_0 = [2Q^2/(ma^3)]^{1/2}$, where m is the mass of a particle. In the simulation, the screening parameter is kept constant at $\kappa = 1$, as it is the most typical value found in an experiment, while Γ and γ are varied to realize different equilibrium states and different damping rates.

Our simulation is directly mimicking recent experiments [1, 2], and is different from the usual method of non-equilibrium simulation for heat conduction [4]. The system is first brought to an equilibrium with desired temperature (T_0) in either liquid or solid state. The melting point for $\kappa = 1$ is at $\Gamma^* \approx 180$ [5], and we will denote the corresponding temperature as T^* . Then the right-half of the system ($x > 0$) is heated to a higher temperature (T_1) by applying a Gaussian white noise with desired strength. The evolution of the temperature profile and also the heat flux are recorded. A steady state is approached after a substantially long period.

The microscopic heat flux for the i th particle is defined as $\mathbf{J}_i(t) = \mathbf{v}_i E_i + \frac{1}{2} \sum_{j=1, j \neq i}^N \mathbf{r}_{ij} (\mathbf{F}_{ij} \cdot \mathbf{v}_{ij}) - \mathbf{r}_i (\mathbf{F}_{\text{ext}} \cdot \mathbf{v}_i)$ where $E_i = (1/2)(mv_i^2 + \sum_{j=1, j \neq i}^N \phi_{ij}) + \phi_{\text{ext}}$ is the particle energy. The total flux in a region is then a summation of the microscopic flux of all particles therein divided by its area A , i.e., $\mathbf{J}(t) = (1/A) \sum_{i \in A} \mathbf{J}_i(t)$. We are mainly interested in the x -component of the heat flux J_x . The three terms on the right-hand side of the above equation correspond to respectively contributions from: (1) the particle migration, which is believed to be the main mechanism of heat transport in gas and is denoted as J_{kx} hereafter, (2) particle interactions, i.e., phonon scattering, which is dominant in solids and is denoted as J_{px} hereafter and (3) the external force. Since the external force acts on only a few rows of particles around the two confining boundaries, its *direct* influence on the heat flux is localized. Neglecting the external contribution will bring it back to the standard one [6, 7].

Analytical model

The heat transfer in our specific case can be described by Fourier's law: $\mathbf{J} = -\lambda \nabla T$ together with energy balance between heat conduction and energy dissipation due to damping: $\nabla \cdot (\lambda \nabla T) = 2\gamma n(T - T_0)k_B$ [2], where λ is the heat conductivity. One has

$$\begin{aligned} T(x) - T_0 &= \frac{T_1 - T_0}{2} \exp\left(\sqrt{\frac{2n\gamma k_B}{\lambda}} x\right), & (x < 0); \\ T(x) - T_1 &= \frac{T_0 - T_1}{2} \exp\left(-\sqrt{\frac{2n\gamma k_B}{\lambda}} x\right), & (x > 0). \end{aligned} \quad (1)$$

Expressions for the heat flux may be obtained in a straightforward way, and we omit the results here. Since λ is the only unknown parameter in equation (1), it may be measured by fitting the stationary temperature profile (STP) to equation (1). It should also be mentioned that Fourier's law could break down for low-dimensional crystalline systems [7], largely due to a slow decay of equilibrium correlations of the heat current and a divergence of the finite-size conductivity. However, both of them may be avoided in dusty plasmas because of the finite damping effect. Therefore, we skip this question at this moment, while interested readers may find more discussions in [7].

Results and discussions

Figure 1(a) shows examples of STPs for different system states and temperature gradients with $\gamma = 0.05\omega_0$, which is close to the experimental condition of [2]. Symbols are measurements

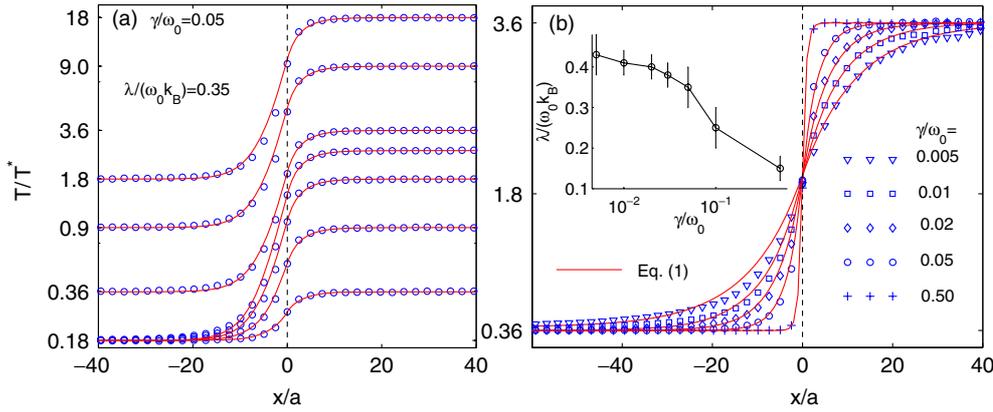


Figure 1. Stationary temperature profiles for: (a) $\gamma = 0.05\omega_0$ but different system states and temperature gradients and (b) $T_0 = 0.36T^*$ and $T_1 = 3.6T^*$ but different damping rates. In both figures, symbols are simulation results while solid lines are fits according to equation (1). For (a) $\lambda = 0.35\omega_0 k_B$, and for (b) different λ values (given in the inserted plot) are obtained.

from simulation, while solid lines are analytical fits according to equation (1). These fits give a constant heat conductivity, $\lambda = (0.35 \pm 0.05)\omega_0 k_B$, or in terms of thermal diffusivity D_T : $D_T \approx 22 \text{ mm}^2 \text{ s}^{-1}$ using parameters from [2]. This value is between the experimental measurement for the crystalline state ($30 \text{ mm}^2 \text{ s}^{-1}$) [1] and that for the solid/liquid mixture phase ($9 \text{ mm}^2 \text{ s}^{-1}$) [2]. Fits for high temperature (e.g. the two upper-most curves) suggest a slightly smaller λ . Nevertheless, the value is in the range of the error bar for the present measurement.

Figure 1(b) shows STPs for different damping rates with other parameters fixed. Fits with equation (1) give a damping-dependent heat conductivity, as is shown in the inserted plot that λ rises slightly with the decrease of γ . Note that this tendency is contradictory with that given by the analytical model in [8], which predicts an increase of λ with an increase of damping rate and was confirmed by their experiment [8]. However, this model is based on an empirical relation between diffusion and heat conduction coefficients obtained by fitting simulation results for the three-dimensional (3D) simple liquid without damping, and their experiment was also performed in a 3D dusty plasma liquid [8]. In contrast, we study here 2D systems covering both liquid and solid states and/or with a liquid–solid mixture phase. So the discrepancy could have been caused by the different dimensionality and system states, as it is known that transport processes depend greatly on these two factors. In our simulation, the damping effect is taken into account self-consistently and increase of λ with decrease of γ may be intuitively understood as follows. It has two effects on heat conduction: direct energy dissipation and indirect suppression of phonon propagation. The first one is only related to kinetic energy of the system, and had been explicitly taken into account in equation (1), whereas the second one affects the collective modes and is not included in equation (1). Therefore, decrease of γ means less damping of phonon propagation, more efficient heat transfer through phonon scattering and consequently a higher heat conductivity.

Figure 2 shows distributions of J_x , J_{px} and J_{kx} for different system states and temperature gradients, together with the analytical result derived from equation (1). First, it may be seen that the kinetic part J_{kx} and the phonon part J_{px} have different weights in different system states. As expected, J_{px} is clearly dominant for the solid state and low temperature liquid state, while J_{kx} dominates for the high temperature liquid. The critical temperature where

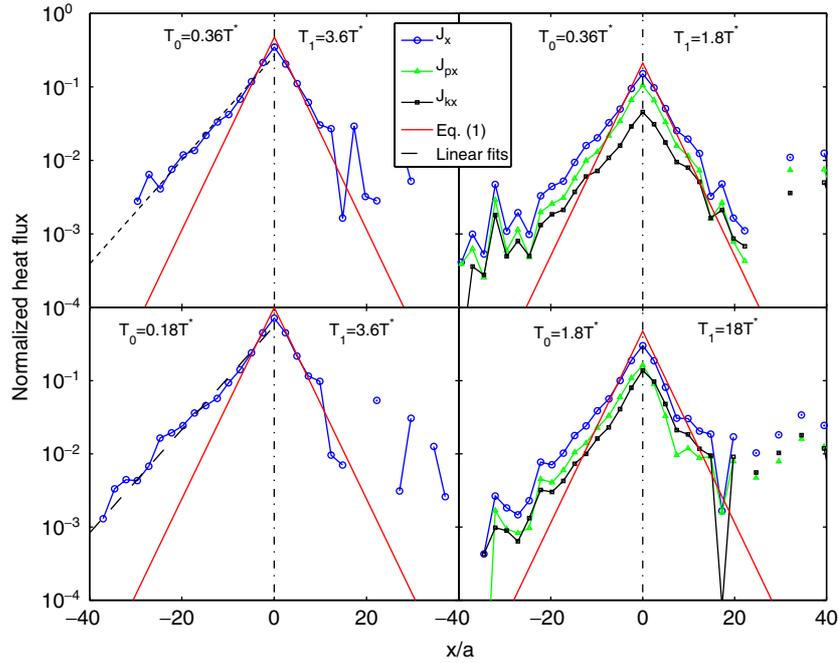


Figure 2. Heat flux for different system states and different temperature gradients with $\gamma = 0.05\omega_0$. Symbols are simulation results, solid lines are fits according to equation (1), using $\lambda = 0.35\omega_0 k_B$, and dashed lines in the two panels on the left are direct linear fits of the heat flux with $\lambda = 1.2\omega_0 k_B$.

the two parts become equal is about $6T^*$. Second, the heat flux is not symmetrical about the heating interface. The decay of the heat flux on the low-temperature side is slower and one needs a smaller slope, consequently a larger λ to fit J_x on this side, indicating a higher heat conductivity for lower temperature. Third, the agreement between analytical results and simulation depends closely on system states. One generally observes a better agreement on the high temperature side and for higher temperature. These features suggest that λ becomes temperature dependent.

Thus, we have measured the heat conductivity λ of 2D SCDPs by analyzing both the stationary temperature profile and heat flux in non-equilibrium simulations. It is found that λ increases with the decrease of the damping rate. In addition, our results also suggest that λ should be temperature dependent.

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